

AK4529

High Performance Multi-channel Audio CODEC

GENERAL DESCRIPTION

The AK4529 is a single chip CODEC that includes two channels of ADC and eight channels of DAC. The ADC outputs 24bit data and the DAC accepts up to 24bit input data. The ADC has the Enhanced Dual Bit architecture with wide dynamic range. The DAC introduces the new developed Advanced Multi-Bit architecture, and achieves wider dynamic range and lower outband noise. An auxiliary digital audio input interface maybe used instead of the ADC for passing audio data to the primary audio output port. Control may be set directly by pins or programmed through a separate serial interface.

The AK4529 has a dynamic range of 102dB for ADC, 106dB for DAC and is well suited for digital surround for home theater and car audio. An AC-3 system can be built with a IEC60958(SPDIF) receiver such as the AK4112A. The AK4529 is available in a small 44pin LQFP package which will reduce system space.

*AC-3 is a trademark of Dolby Laboratories.

FEATURES

☐ 2ch 24bit ADC

- 64x Oversampling
- Sampling Rate up to 96kHz
- Linear Phase Digital Anti-Alias Filter
- Single-Ended Input
- S/(N+D): 92dB
- Dynamic Range, S/N: 102dB
- Digital HPF for offset cancellation
- I/F format: MSB justified, I2S or TDM
- Overflow flag

☐ 8ch 24bit DAC

- 128x Oversampling
- Sampling Rate up to 96kHz
- 24bit 8 times Digital Filter
- Single-Ended Outputs
- On-chip Switched-Capacitor Filter
- S/(N+D): 90dB
- Dynamic Range, S/N: 106dB
- I/F format: MSB justified, LSB justified(20bit,24bit), I2S or TDM
- Individual channel digital volume with 256 levels and 0.5dB step
- Soft mute
- De-emphasis for 32kHz, 44.1kHz and 48kHz
- Zero Detect Function

☐ High J	itter To	lerance
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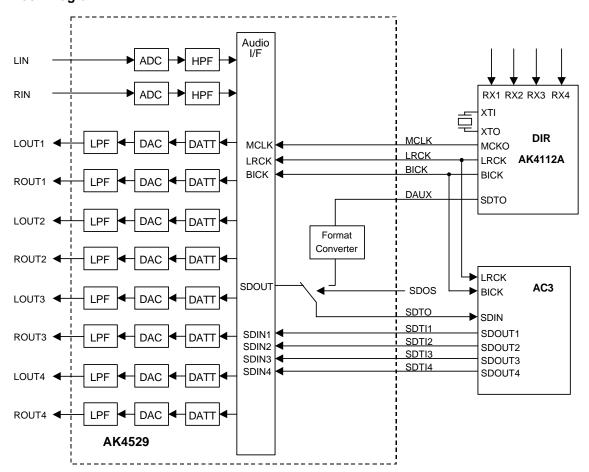
- ☐ TTL Level Digital I/F
- □ 3-wire Serial and I²C Bus µP I/F for mode setting
- ☐ Master clock:256fs, 384fs or 512fs for fs=32kHz to 48kHz 128fs, 192fs or 256fs for fs=64kHz to 96kHz

☐ Power Supply: 4.5 to 5.5V

- ☐ Power Supply for output buffer: 2.7 to 5.5V
- ☐ Small 44pin LQFP

MS0082-E-00 2001/3

■ Block Diagram



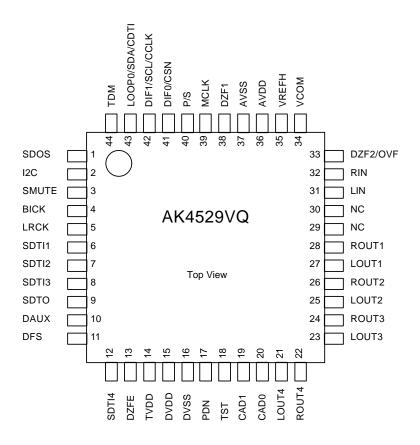
Block Diagram (DIR and AC-3 DSP are external parts)

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■ Ordering Guide

AK4529VQ $-40 \sim +85$ °C 44pin LQFP(0.8mm pitch) AKD4529 Evaluation Board for AK4529

■ Pin Layout



■ Compatibility with AK4527B

1. Functions

Functions	AK4527B	AK4529
DAC channel	6ch	8ch
ADC	Full-differential input	Single-ended input
	(with single-ended use capability)	
DATT transition time	7424/fs (fixed)	7424/fs, 1024/fs or 256/fs
I ² C bus auto increment	Not available	Available
TDM I/F format	Not available	Available

2. Pin Configuration

pin#	AK4527	AK4529
12	NC	SDTI4
19	NC	CAD1
20	NC	CAD0
21	CAD1	LOUT4
22	CAD0	ROUT4
29	LIN-	NC
30	LIN+	NC
31	RIN-	LIN
32	RIN+	RIN
44	LOOP1	TDM

3. Register

Addr	Changed items
00H	TDM (TDM I/F format mode) is added.
08H	DEMD1-0 (DAC4 De-emphasis) are added.
09H	ATS1-0 (DATT transition time) are added.
0AH	DZFM3 (Zero detection mode) is added.
0BH	ATT7-0 (LOUT4 output volume control) are added.
0CH	ATT7-0 (ROUT4 output volume control) are added.

PIN/FUNCTION

No.	Pin Name	I/O	Function
1	SDOS	I	SDTO Source Select Pin (Note 1)
			"L": Internal ADC output, "H": DAUX input
			SDOS pin should be set to "L" when TDM= "1".
2	I2C	I	Control Mode Select Pin
			"L": 3-wire Serial, "H": I ² C Bus
3	SMUTE	I	Soft Mute Pin (Note 1)
			When this pin goes to "H", soft mute cycle is initialized.
			When returning to "L", the output mute releases.
4	BICK	I	Audio Serial Data Clock Pin
5	LRCK	I	Input Channel Clock Pin
6	SDTI1	I	DAC1 Audio Serial Data Input Pin
7	SDTI2	I	DAC2 Audio Serial Data Input Pin
8	SDTI3	I	DAC3 Audio Serial Data Input Pin
9	SDTO	О	Audio Serial Data Output Pin
10	DAUX	I	AUX Audio Serial Data Input Pin
11	DFS	I	Double Speed Sampling Mode Pin (Note 1)
			"L": Normal Speed, "H": Double Speed
12	SDTI4	I	DAC4 Audio Serial Data Input Pin
13	DZFE	I	Zero Input Detect Enable Pin
			"L": mode 7 (disable) at parallel mode,
			zero detect mode is selectable by DZFM3-0 bits at serial mode
			"H": mode 0 (DZF1 is AND of all eight channels)
14	TVDD	-	Output Buffer Power Supply Pin, 2.7V~5.5V
15	DVDD	-	Digital Power Supply Pin, 4.5V~5.5V
16	DVSS	-	Digital Ground Pin, 0V
17	PDN	I	Power-Down & Reset Pin
			When "L", the AK4529 is powered-down and the control registers are reset to default
			state. If the state of P/S or CAD0-1 changes, then the AK4529 must be reset by PDN.
18	TST	I	Test Pin
			This pin should be connected to DVSS.
19	CAD1	I	Chip Address 1 Pin
20	CAD0	I	Chip Address 0 Pin
21	LOUT4	0	DAC4 Lch Analog Output Pin
22	ROUT4	О	DAC4 Rch Analog Output Pin

No.	Pin Name	I/O	Function
23	LOUT3	О	DAC3 Lch Analog Output Pin
24	ROUT3	О	DAC3 Rch Analog Output Pin
25	LOUT2	О	DAC2 Lch Analog Output Pin
26	ROUT2	О	DAC2 Rch Analog Output Pin
27	LOUT1	О	DAC1 Lch Analog Output Pin
28	ROUT1	О	DAC1 Rch Analog Output Pin
29	NC	-	No Connect
			No internal bonding.
30	NC	-	No Connect
			No internal bonding.
31	LIN	I	Lch Analog Input Pin
32	RIN	I	Rch Analog Input Pin
33	DZF2	О	Zero Input Detect 2 Pin (Note 2)
			When the input data of the group 1 follow total 8192 LRCK cycles with "0" input data,
			this pin goes to "H".
	OVF	О	Analog Input Overflow Detect Pin (Note 3)
			This pin goes to "H" if the analog input of Lch or Rch is overflows.
34	VCOM	О	Common Voltage Output Pin, AVDD/2
			Large external capacitor around 2.2µF is used to reduce power-supply noise.
35	VREFH	I	Positive Voltage Reference Input Pin, AVDD
36	AVDD	-	Analog Power Supply Pin, 4.5V~5.5V
37	AVSS	-	Analog Ground Pin, 0V
38	DZF1	О	Zero Input Detect 1 Pin (Note 2)
			When the input data of the group 1 follow total 8192 LRCK cycles with "0" input data,
			this pin goes to "H".
39	MCLK	I	Master Clock Input Pin
40	P/S	I	Parallel/Serial Select Pin
			"L": Serial control mode, "H": Parallel control mode
41	DIF0	I	Audio Data Interface Format 0 Pin in parallel control mode
	CSN	I	Chip Select Pin in 3-wire serial control mode
			This pin should be connected to DVDD at I ² C bus control mode
42	DIF1	I	Audio Data Interface Format 1 Pin in parallel control mode
	SCL/CCLK	I	Control Data Clock Pin in serial control mode
			I2C = "L": CCLK (3-wire Serial), I2C = "H": SCL (I ² C Bus)
43	LOOP0	I	Loopback Mode 0 Pin in parallel control mode
	an 1 /an	T/0	Enables digital loop-back from ADC to 4 DACs.
	SDA/CDTI	I/O	Control Data Input Pin in serial control mode
	mp) (_	I2C = "L": CDTI (3-wire Serial), I2C = "H": SDA (I ² C Bus)
44	TDM	I	TDM I/F Format Mode Pin (Note 1)
			"L": Normal format, "H": TDM format

Notes: 1. SDOS, SMUTE, DFS, and TDM pins are ORed with register data if P/S = "L".

- 2. The group 1 and 2 can be selected by DZFM3-0 bits if P/S = "L" and DZFE = "L".
- 3. This pin becomes OVF pin if OVFE bit is set to "1" at serial control mode.
- 4. All input pins should not be left floating.

ABSOLUTE MAXIMUM RATINGS

(AVSS, DVSS=0V; Note 5)

Parameter		Symbol	min	max	Units
Power Supplies	Analog	AVDD	-0.3	6.0	V
	Digital	DVDD	-0.3	6.0	V
	Output buffer	TVDD	-0.3	6.0	V
	AVSS-DVSS (Note 6)	ΔGND	-	0.3	V
Input Current (any	pins except for supplies)	IIN	-	±10	mA
Analog Input Volt	rage	VINA	-0.3	AVDD+0.3	V
Digital Input Voltage		VIND	-0.3	DVDD+0.3	V
Ambient Tempera	ture (power applied)	Ta	-40	85	°C
Storage Temperat	ure	Tstg	-65	150	°C

Notes: 5. All voltages with respect to ground.

6. AVSS and DVSS must be connected to the same analog ground plane.

WARNING: Operation at or beyond these limits may result in permanent damage to the device. Normal operation is not guaranteed at these extremes.

RECOMMENDED OPERATING CONDITIONS							
(AVSS, DVSS=0V; Note 5)							
Parameter		Symbol	min	typ	max	Units	
Power Supplies	Analog	AVDD	4.5	5.0	5.5	V	
(Note 7)	Digital	DVDD	4.5	5.0	5.5	V	
	Output buffer	TVDD	2.7	5.0	5.5	V	

Notes: 5. All voltages with respect to ground.

7. The power up sequence between AVDD, DVDD and TVDD is not critical.

WARNING: AKM assumes no responsibility for the usage beyond the conditions in this datasheet.

ANALOG CHARACTERISTICS

(Ta=25°C; AVDD, DVDD, TVDD=5V; AVSS, DVSS=0V; VREFH=AVDD; fs=44.1kHz; BICK=64fs; Signal Frequency=1kHz; 24bit Data; Measurement Frequency=20Hz~20kHz at 44.1kHz, 20Hz~40kHz at fs=96kHz; unless otherwise specified)

Parameter Parameter			min	typ	max	Units
ADC Analog Inp	out Characteri	stics			•	•
Resolution					24	Bits
S/(N+D)	(-0.5dBFS)	fs=44.1kHz	84	92		dB
		fs=96kHz	-	86		dB
DR	(-60dBFS)	fs=44.1kHz, A-weighted	94	102		dB
		fs=96kHz	88	96		dB
		fs=96kHz, A-weighted	93	102		dB
S/N	(Note 8)	fs=44.1kHz, A-weighted	94	102		dB
		fs=96kHz	88	96		dB
T . 1 1T 1		fs=96kHz, A-weighted	93	102		dB
Interchannel Isola	ation		90	110		dB
DC Accuracy	3.61			0.0	0.2	15
Interchannel Gair	n Mismatch			0.2	0.3	dB
Gain Drift	1 0 4	4 41 11 4 11 0 62 11 11 11 11	2.00	20	-	ppm/°C
Input Voltage		4.1kHz AIN=0.62xVREFH	2.90	3.10	3.30	Vpp
In most Desistance	IS=9	6kHz AIN=0.65xVREFH	3.05	3.25	3.45	Vpp
Input Resistance	• .•	(Note 9)	15	25		kΩ
Power Supply Re		(Note 10)		50		dB
DAC Analog Ou	tput Characte	ristics				1
Resolution					24	Bits
S/(N+D)		fs=44.1kHz	80	90		dB
DD	(co IDEG)	fs=96kHz	78	88		dB
DR	(-60dBFS)	fs=44.1kHz, A-weighted fs=96kHz	95 88	106		dB
		fs=96kHz, A-weighted	88 94	100 106		dB dB
S/N	(Note 11)	fs=44.1kHz, A-weighted	95	106		dB
S/1N	(Note 11)	fs=96kHz	88	100		dB
		fs=96kHz, A-weighted	94	106		dB
Interchannel Isola	ation	15 yours, 11 weighted	90	110		dB
DC Accuracy		L			l	
Interchannel Gair	Mismatch			0.2	0.5	dB
Gain Drift	1 1/11/5/11/accii			20	-	ppm/°C
Output Voltage	AOU	T=0.6xVREFH	2.75	3.0	3.25	Vpp
Load Resistance	7100	2 0.00. 110.11	5	3.0	3.23	kΩ
Power Supply Re	viection	(Note 10)	<u> </u>	50		dB
Power Supplies	Jeenon	(11010-10)		50	l	uD
Power Supply Cu	rrent (AVDD+1	DVDD+TVDD)				
	ion (PDN = "H					
AVDD	•			42	63	mA
DVDD+TVI	DD fs=44.1kH	(Note 12)		28	42	mA
	fs=96kHz			42	63	mA
	ode (PDN = "L	") (Note 13)		80	200	μA

Notes: 8. S/N measured by CCIR-ARM is 98dB(@fs=44.1kHz).

- 9. Input resistance is $16k\Omega$ typically at fs=96kHz.
- 10. PSR is applied to AVDD, DVDD and TVDD with 1kHz, 50mVpp. VREFH pin is held a constant voltage.
- 11. S/N measured by CCIR-ARM is 102dB(@fs=44.1kHz).
- 12. TVDD=0.1mA(typ).
- 13. In the power-down mode. All digital input pins including clock pins (MCLK, BICK, LRCK) are held DVSS.

FILTER CHARACTERISTICS

(Ta=25°C; AVDD, DVDD=4.5~5.5V; TVDD=2.7~5.5V; fs=44.1kHz; DEM=OFF)

Parameter			Symbol	min	typ	max	Units
ADC Digital Filter (De	ecimation LPI	F):					
Passband	(Note 14)	-0.005dB	PB	0		19.76	kHz
		-0.02dB		-	20.02	-	kHz
		-0.06dB		-	20.20	-	kHz
		-6.0dB		-	22.05	-	kHz
Stopband			SB	24.34			kHz
Passband Ripple			PR			±0.005	dB
Stopband Attenuation			SA	80			dB
Group Delay	(Note 15)		GD		27.6		1/fs
Group Delay Distortion			$\Delta \mathrm{GD}$		0		μs
ADC Digital Filter (HI	P F):						•
Frequency Response	(Note 14)	-3dB	FR		0.9		Hz
		-0.5dB			2.7		Hz
		-0.1dB			6.0		Hz
DAC Digital Filter:							
Passband	(Note 14)	-0.1dB	PB	0		20.0	kHz
		-6.0dB		ı	22.05	-	kHz
Stopband			SB	24.2			kHz
Passband Ripple			PR			±0.02	dB
Stopband Attenuation			SA	56			dB
Group Delay	(Note 15)		GD		21.9		1/fs
DAC Digital Filter + A	nalog Filter:						
Frequency Response:	0 ~ 20.0kHz		FR		±0.2		dB
	40.0kHz	(Note 16)	FR		±0.3		dB

Notes: 14. The passband and stopband frequencies scale with fs.

For example, 20.02kHz at -0.02dB is 0.454 x fs. The reference frequency of these responses is 1kHz.

15. The calculating delay time which occurred by digital filtering. This time is from setting the input of analog signal to setting the 24bit data of both channels to the output register for ADC. For DAC, this time is from setting the 20/24bit data of both channels on input register to the output of analog signal.

16. fs=96kHz.

DC CHARACTERISTICS

(Ta=25°C; AVDD, DVDD=4.5~5.5V; TVDD=2.7~5.5V)

Parameter	Symbol	min	typ	max	Units
High-Level Input Voltage	VIH	2.2	-	-	V
Low-Level Input Voltage	VIL	-	-	0.8	V
High-Level Output Voltage					
(SDTO pin: Iout=-	100μA) VOH	TVDD-0.5	-	-	V
(DZF1, DZF2/OVF pins: Iout=-1	.00μA) VOH	AVDD-0.5	-	-	V
Low-Level Output Voltage					
(SDTO, DZF1, DZF2/OVF pins: Iout= 1	100μA) VOL	-	-	0.5	V
(SDA pin: Iout=	3mA) VOL	-	-	0.4	V
Input Leakage Current	Iin	-	-	±10	μΑ

SWITCHING CHARACTERISTICS

(Ta=25°C; AVDD, DVDD=4.5~5.5V; TVDD=2.7~5.5V; C_L=20pF)

Parameter	Symbol	min	typ	max	Units
Master Clock Timing					
256fsn, 128fsd:	fCLK	8.192		12.288	MHz
Pulse Width Low	tCLKL	27			ns
Pulse Width High	tCLKH	27			ns
384fsn, 192fsd:	fCLK	12.288		18.432	MHz
Pulse Width Low	tCLKL	20			ns
Pulse Width High	tCLKH	20			ns
512fsn, 256fsd:	fCLK	16.384		24.576	MHz
Pulse Width Low	tCLKL	15			ns
Pulse Width High	tCLKH	15			ns
LRCK Timing					
TDM= "0"					
Normal Speed Mode	fsn	32		48	kHz
Double Speed Mode	fsd	64		96	kHz
Duty Cycle	Duty	45		55	%
TDM= "1"					
LRCK frequency	fsn	32		48	kHz
"H" time	tLRH	1/256fs			ns
"L" time	tLRL	1/256fs			ns
Audio Interface Timing					
TDM= "0"					
BICK Period	tBCK	160			ns
BICK Pulse Width Low	tBCKL	65			ns
Pulse Width High	tBCKH	65			ns
LRCK Edge to BICK "\" (Note 17)	tLRB	45			ns
BICK "↑" to LRCK Edge (Note 17)	tBLR	45			ns
LRCK to SDTO(MSB)	tLRS			40	ns
BICK "↓" to SDTO	tBSD			40	ns
SDTI1-4, DAUX Hold Time	tSDH	40			ns
SDTI1-4, DAUX Setup Time	tSDS	25			ns
TDM= "1"					
BICK Period	tBCK	81			ns
BICK Pulse Width Low	tBCKL	32			ns
Pulse Width High	tBCKH	32			ns
LRCK Edge to BICK "\" (Note 17)	tLRB	20			ns
BICK "↑" to LRCK Edge (Note 17)	tBLR	20			ns
BICK "↓" to SDTO	tBSD			20	ns
SDTI1 Hold Time	tSDH	10			ns
SDTI1 Setup Time	tSDS	10			ns

Notes: 17. BICK rising edge must not occur at the same time as LRCK edge.

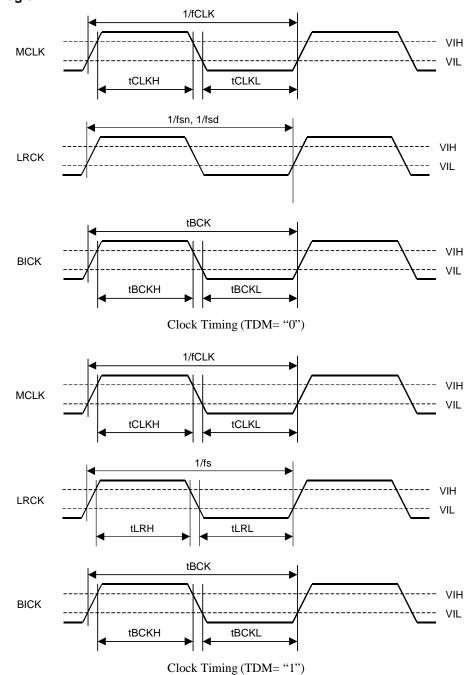
Parameter	Symbol	min	typ	max	Units
Control Interface Timing (3-wire Serial mode):					
CCLK Period	tCCK	200			ns
CCLK Pulse Width Low	tCCKL	80			ns
Pulse Width High	tCCKH	80			ns
CDTI Setup Time	tCDS	40			ns
CDTI Hold Time	tCDH	40			ns
CSN "H" Time	tCSW	150			ns
CSN "↓" to CCLK "↑"	tCSS	50			ns
CCLK "↑" to CSN "↑"	tCSH	50			ns
Rise Time of CSN	tR1			20	ns
Fall Time of CSN	tF1			20	ns
Rise Time of CCLK	tR2			20	ns
Fall Time of CCLK	tF2			20	ns
Control Interface Timing (I ² C Bus mode):					
SCL Clock Frequency	fSCL	-		100	kHz
Bus Free Time Between Transmissions	tBUF	4.7		-	μs
Start Condition Hold Time (prior to first clock pulse)	tHD:STA	4.0		-	μs
Clock Low Time	tLOW	4.7		-	μs
Clock High Time	tHIGH	4.0		-	μs
Setup Time for Repeated Start Condition	tSU:STA	4.7		-	μs
SDA Hold Time from SCL Falling (Note 18)	tHD:DAT	0		-	μs
SDA Setup Time from SCL Rising	tSU:DAT	0.25		-	μs
Rise Time of Both SDA and SCL Lines	tR	-		1.0	μs
Fall Time of Both SDA and SCL Lines	tF	-		0.3	μs
Setup Time for Stop Condition	tSU:STO	4.0		-	μs
Pulse Width of Spike Noise Suppressed by Input Filt	er tSP	0		50	ns
Power-down & Reset Timing				_	
PDN Pulse Width (Note 19)	tPD	150			ns
PDN "↑" to SDTO valid (Note 20)	tPDV		522		1/fs

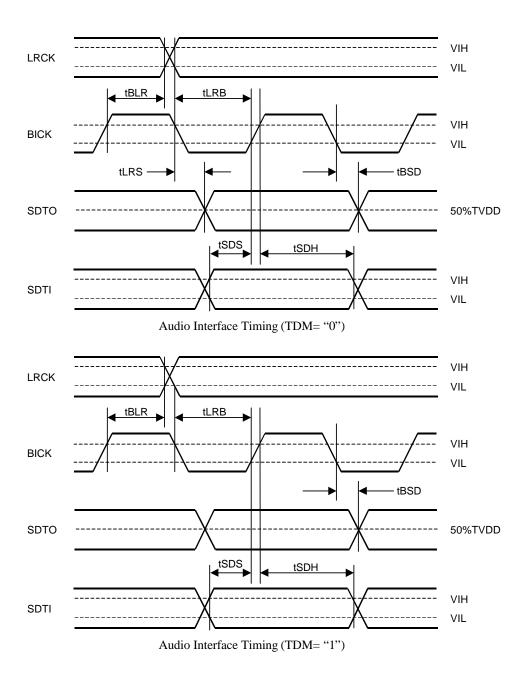
Notes: 18. Data must be held for sufficient time to bridge the 300 ns transition time of SCL.

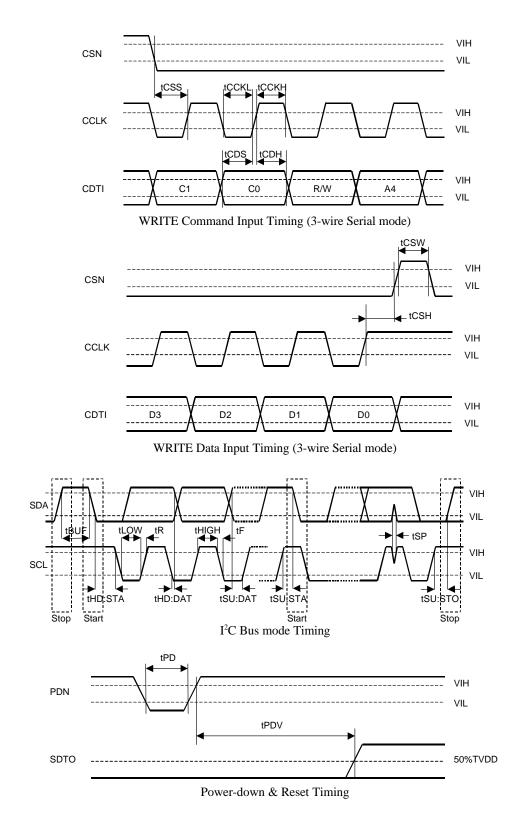
- 19. The AK4529 can be reset by bringing PDN "L" to "H" upon power-up.
- 20. These cycles are the number of LRCK rising from PDN rising.
- 21. I²C is a registered trademark of Philips Semiconductors.

Purchase of Asahi Kasei Microsystems Co., Ltd I^2C components conveys a license under the Philips I^2C patent to use the components in the I^2C system, provided the system conform to the I^2C specifications defined by Philips.

■ Timing Diagram







OPERATION OVERVIEW

■ System Clock

The external clocks, which are required to operate the AK4529, are MCLK, LRCK and BICK. There are two methods to set MCLK frequency. In Manual Setting Mode (ACKS = "0": Default), the sampling speed is set by DFS (Table 1). The frequency of MCLK at each sampling speed is set automatically. (Table 2, 3). In Auto Setting Mode (ACKS = "1"), as MCLK frequency is detected automatically (Table 4), and the internal master clock becomes the appropriate frequency (Table 5), it is not necessary to set DFS.

MCLK should be synchronized with LRCK but the phase is not critical. External clocks (MCLK, BICK) should always be present whenever the AK4529 is in normal operation mode (PDN = "H"). If these clocks are not provided, the AK4529 may draw excess current because the device utilizes dynamic refreshed logic internally. If the external clocks are not present, the AK4529 should be in the power-down mode (PDN = "L") or in the reset mode (RSTN = "0"). After exiting reset at power-up etc., the AK4529 is in the power-down mode until MCLK and LRCK are input.

DFS	Sampling S		
0	Normal Speed Mode	32kHz~48kHz	Default
1	Double Speed Mode	64kHz~96kHz	

Table 1. Sampling Speed (Manual Setting Mode)

LRCK		BICK (MHz)		
fs	256fs	384fs	512fs	64fs
32.0kHz	8.1920	12.2880	16.3840	2.0480
44.1kHz	11.2896	16.9344	22.5792	2.8224
48.0kHz	12.2880	18.4320	24.5760	3.0720

Table 2. System Clock Example (Normal Speed Mode @Manual Setting Mode)

LRCK		BICK (MHz)		
fs	128fs	192fs	256fs	64fs
88.2kHz	11.2896	16.9344	22.5792	5.6448
96.0kHz	12.2880	18.4320	24.5760	6.1440

Table 3. System Clock Example (Double Speed Mode @Manual Setting Mode) (Note: At double speed mode(DFS = "1"), 128fs and 192fs are not available for ADC.)

MCLK	Sampling Speed
512fs	Normal
256fs	Double

Table 4. Sampling Speed (Auto Setting Mode)

LRCK	MCLK	Sampling	
fs	256fs	512fs	Speed
32.0kHz	-	16.3840	
44.1kHz	-	22.5792	Normal
48.0kHz	-	24.5760	
88.2kHz	22.5792	-	Double
96.0kHz	24.5760	-	Double

Table 5. System Clock Example (Auto Setting Mode)

■ De-emphasis Filter

The AK4529 includes the digital de-emphasis filter (tc= $50/15\mu$ s) by IIR filter. This filter corresponds to three sampling frequencies (32kHz, 44.1kHz, 48kHz). De-emphasis of each DAC can be set individually by register data of DEMA1-C0 (DAC1: DEMA1-0, DAC2: DEMB1-0, DAC3: DEMC1-0, see "Register Definitions").

Mode	Sampling Speed	DEM1	DEM0	DEM
0	Normal Speed	0	0	44.1kHz
1	Normal Speed	0	1	OFF
2	Normal Speed	1	0	48kHz
3	Normal Speed	1	1	32kHz
4	Double Speed	0	0	OFF
5	Double Speed	0	1	OFF
6	Double Speed	1	0	OFF
7	Double Speed	1	1	OFF

Default

Table 6. De-emphasis control

■ Digital High Pass Filter

The ADC has a digital high pass filter for DC offset cancel. The cut-off frequency of the HPF is 0.9Hz at fs=44.1kHz and also scales with sampling rate (fs).

■ Audio Serial Interface Format

When TDM= "L", four modes can be selected by the DIF1-0 as shown in table 7. In all modes the serial data is MSB-first, 2's compliment format. The SDTO is clocked out on the falling edge of BICK and the SDTI/DAUX are latched on the rising edge of BICK.

Figures 1~4 shows the timing at SDOS = "L". In this case, the SDTO outputs the ADC output data. When SDOS = "H", the data input to DAUX is converted to SDTO's format and output from SDTO. Mode 2, 3, 6 and 7 in SDTI input formats can be used for 16-20bit data by zeroing the unused LSBs.

Mode	TDM	DIF1	DIF0	SDTO	SDTI1-4, DAUX	LRCK	BICK
0	0	0	0	24bit, Left justified	20bit, Right justified	H/L	≥ 48fs
1	0	0	1	24bit, Left justified	24bit, Right justified	H/L	≥ 48fs
2	0	1	0	24bit, Left justified	24bit, Left justified	H/L	≥ 48fs
3	0	1	1	24bit, I ² S	24bit, I ² S	L/H	≥ 48fs

Default

Table 7. Audio data formats (Normal format)

The audio serial interface format becomes the TDM I/F format if TDM pin is set to "H". In the TDM mode, the serial data of all DAC (eight channels) is input to the SDTI1 pin. The input data to SDTI2-4 pins is ignored. BICK should be fixed to 256fs. "H" time and "L" time of LRCK should be 1/256fs at least. Four modes can be selected by the DIF1-0 as shown in table 8. In all modes the serial data is MSB-first, 2's compliment format. The SDTO is clocked out on the falling edge of BICK and the SDTI1 are latched on the rising edge of BICK. SDOS and LOOP1-0 should be set to "0" at the TDM mode. TDM mode cannot be used in double speed mode.

Mode	TDM	DIF1	DIF0	SDTO	SDTI1	Sync	BICK
4	1	0	0	24bit, Left justified	20bit, Right justified	↑	256fs
5	1	0	1	24bit, Left justified	24bit, Right justified	↑	256fs
6	1	1	0	24bit, Left justified	24bit, Left justified	↑	256fs
7	1	1	1	24bit, I ² S	24bit, I ² S	\rightarrow	256fs

Table 8. Audio data formats (TDM format)

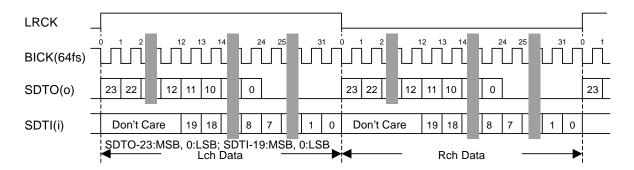


Figure 1. Mode 0 Timing

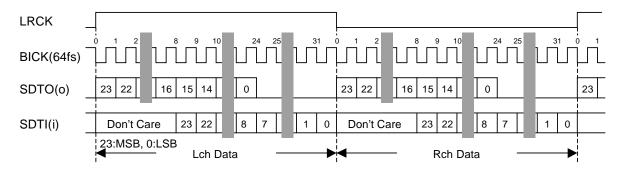


Figure 2. Mode 1 Timing

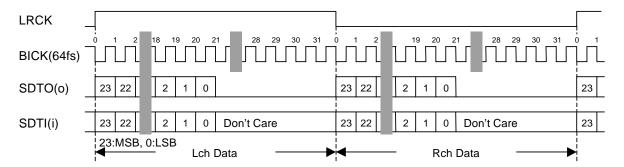


Figure 3. Mode 2 Timing

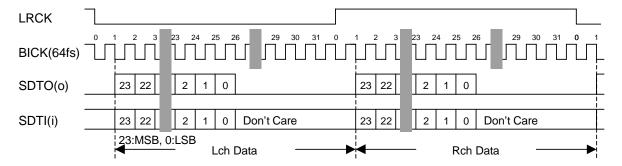


Figure 4. Mode 3 Timing

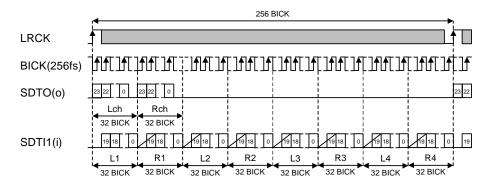


Figure 5. Mode 4 Timing

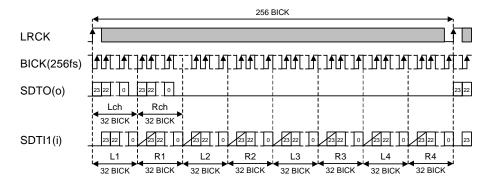


Figure 6. Mode 5 Timing

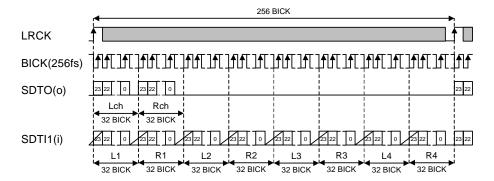


Figure 7. Mode 6 Timing

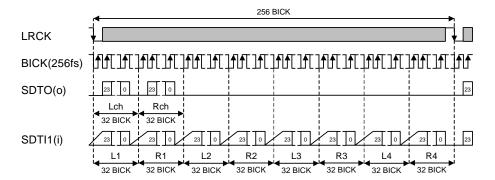


Figure 8. Mode 7 Timing

■ Overflow Detection

The AK4529 has overflow detect function for analog input. Overflow detect function is enable if OVFE bit is set to "1" at serial control mode. OVF pin goes to "H" if analog input of Lch or Rch overflows (more than -0.3dBFS). OVF output for overflowed analog input has the same group delay as ADC (GD = $27.6/\text{fs} = 626\mu\text{s}@\text{fs}=44.1\text{kHz}$). OVF is "L" for 522/fs (=11.8ms @fs=44.1kHz) after PDN = "\", and then overflow detection is enabled.

■ Zero Detection

The AK4529 has two pins for zero detect flag outputs. Channel grouping can be selected by DZFM3-0 bits if P/S = "L" and DZFE = "L" (table 9). DZF1 pin corresponds to the group 1 channels and DZF2 pin corresponds to the group 2 channels. However DZF2 pin becomes OVF pin if OVFE bit is set to "1". Zero detection mode is set to mode 0 if DZFE= "H" regardless of P/S pin. DZF1 is AND of all eight channels and DZF2 is disabled ("L") at mode 0. Table 10 shows the relation of P/S, DZFE, OVFE and DZF.

When the input data of all channels in the group 1(group 2) are continuously zeros for 8192 LRCK cycles, DZF1(DZF2) pin goes to "H". DZF1(DZF2) pin immediately goes to "L" if input data of any channels in the group 1(group 2) is not zero after going DZF1(DZF2) "H".

34.1		DΖ	FM					AO	UT		AOUT					
Mode	3	2	1	0	L1	R1	L2	R2	L3	R3	L4	R4				
0	0	0	0	0	DZF1	DZF1	DZF1	DZF1	DZF1	DZF1	DZF1	DZF1				
1	0	0	0	1	DZF1	DZF1	DZF1	DZF1	DZF1	DZF2	DZF2	DZF2				
2	0	0	1	0	DZF1	DZF1	DZF1	DZF1	DZF2	DZF2	DZF2	DZF2				
3	0	0	1	1	DZF1	DZF1	DZF1	DZF2	DZF2	DZF2	DZF2	DZF2				
4	0	1	0	0	DZF1	DZF1	DZF2	DZF2	DZF2	DZF2	DZF2	DZF2				
5	0	1	0	1	DZF1	DZF2	DZF2	DZF2	DZF2	DZF2	DZF2	DZF2				
6	0	1	1	0	DZF2	DZF2	DZF2	DZF2	DZF2	DZF2	DZF2	DZF2				
7	0	1	1	1			disal	ble (DZF1	=DZF2 =	"L")			Default			
8	1	0	0	0	DZF1	DZF1	DZF1	DZF1	DZF1	DZF1	DZF1	DZF2				
9	1	0	0	1	DZF1	DZF1	DZF1	DZF1	DZF1	DZF1	DZF2	DZF2				
10	1	0	1	0												
11	1	0	1	1												
12	1	1	0	0		disable (DZF1=DZF2 = "L")										
13	1	1	0	1			uisai	DIE (DZI-I	-DZI^2 -	L)						
14	1	1	1	0												
15	1	1	1	1												

Table 9. Zero detect control

P/S pin	DZFE pin	OVFE bit	DZF mode	DZF1 pin	DZF2/OVF pin
"H" (parallel mode)	"L"	disable	Mode 7	"L"	"L"
	"H"	disable	Mode 0	AND of 6ch	"L"
"L" (serial mode)	"L"	"0"	Selectable	Selectable	Selectable
		"1"	Selectable	Selectable	OVF output
	"H"	"0"	Mode 0	AND of 6ch	"L"
		"1"	Mode 0	AND of 6ch	OVF output

Table 10. DZF1-2 pins outputs

■ Digital Attenuator

AK4529 has channel-independent digital attenuator (256 levels, 0.5dB step). Attenuation level of each channel can be set by each ATT7-0 bits (table 11).

ATT7-0	Attenuation Level	
00H	0dB	Default
01H	-0.5dB	
02H	-1.0dB	
:	•	
FDH	-126.5dB	
FEH	-127.0dB	
FFH	MUTE (-∞)	

Table 11. Attenuation level of digital attenuator

Transition time between set values of ATT7-0 bits can be selected by ATS1-0 bits (table 12).

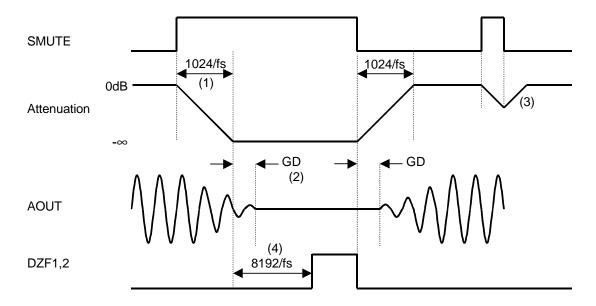
Mode	ATS1	ATS0	ATT speed	
0	0	0	7424/fs	Default
1	0	1	1024/fs	
2	1	0	256/fs	

Table 12. Transition time between set values of ATT7-0 bits

The transition between set values is soft transition of 7425 levels in mode 0. It takes 7424/fs (168ms@fs=44.1kHz) from 00H(0dB) to FFH(MUTE) in mode 0. If PDN pin goes to "L", the ATTs are initialized to 00H. The ATTs are 00H when RSTN = "0". When RSTN return to "1", the ATTs fade to their current value. Digital attenuator is independent of soft mute function.

■ Soft mute operation

Soft mute operation is performed at digital domain. When the SMUTE pin goes to "H", the output signal is attenuated by -∞ during 1024 LRCK cycles. When the SMUTE pin is returned to "L", the mute is cancelled and the output attenuation gradually changes to 0dB during 1024 LRCK cycles. If the soft mute is cancelled within 1024 LRCK cycles after starting the operation, the attenuation is discontinued and returned to 0dB. The soft mute is effective for changing the signal source without stopping the signal transmission.



Notes:

- (1) The output signal is attenuated by -∞ during 1024 LRCK cycles (1024/fs).
- (2) Analog output corresponding to digital input have the group delay (GD).
- (3) If the soft mute is cancelled within 1024 LRCK cycles, the attenuation is discontinued and returned to 0dB.
- (4) When the input data of all channels in the group are continuously zeros for 8192 LRCK cycles, DZF pin corresponding to the group goes to "H". DZF pin immediately goes to "L" if input data of any channel in the group is not zero after going DZF "H".

Figure 9. Soft mute and zero detection

■ System Reset

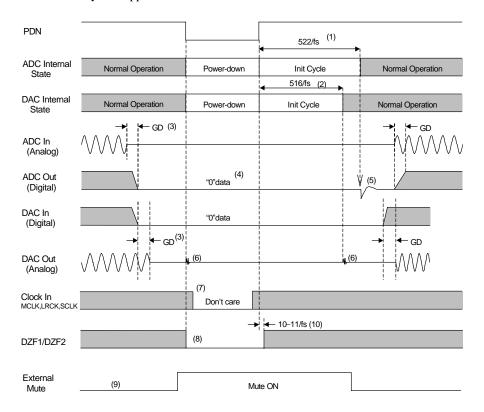
The AK4529 should be reset once by bringing PDN = "L" upon power-up. The AK4529 is powered up and the internal timing starts clocking by LRCK "\" after exiting reset and power down state by MCLK. The AK4529 is in the power-down mode until MCLK and LRCK are input.

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■ Power-Down

The ADC and DACs of AK4529 are placed in the power-down mode by bringing PDN "L" and both digital filters are reset at the same time. PDN "L" also reset the control registers to their default values. In the power-down mode, the analog outputs go to VCOM voltage and DZF1-2 pins go to "L". This reset should always be done after power-up. In case of the ADC, an analog initialization cycle starts after exiting the power-down mode. Therefore, the output data, SDTO becomes available after 522 cycles of LRCK clock. In case of the DAC, an analog initialization cycle starts after exiting the power-down mode. The analog outputs are VCOM voltage during the initialization. Figure 10 shows the power-up sequence.

The ADC and DACs can be powered-down individually by PWADN and PWDAN bits. In this case, the internal register values are not initialized. When PWADN = "0", SDTO goes to "L". When PWDAN = "0", the analog outputs go to VCOM voltage and DZF1-2 pins go to "H". Because some click noise occurs, the analog output should muted externally if the click noise influences system application.



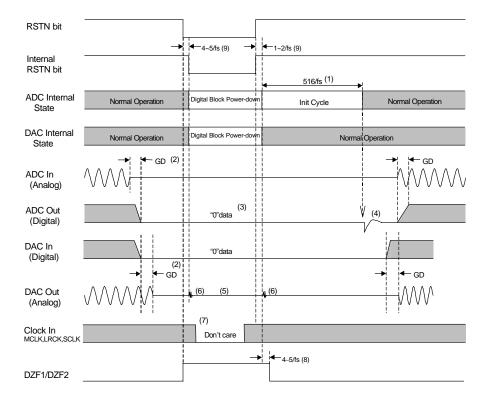
Notes:

- (1) The analog part of ADC is initialized after exiting the power-down state.
- (2) The analog part of DAC is initialized after exiting the power-down state.
- (3) Digital output corresponding to analog input and analog output corresponding to digital input have the group delay (GD).
- (4) ADC output is "0" data at the power-down state.
- (5) Click noise occurs at the end of initialization of the analog part. Please mute the digital output externally if the click noise influences system application.
- (6) Click noise occurs at the falling edge of PDN and at 512/fs after the rising edge of PDN.
- (7) When the external clocks (MCLK, BICK and LRCK) are stopped, the AK4529 should be in the power-down mode.
- (8) DZF pins are "L" in the power-down mode (PDN = "L").
- (9) Please mute the analog output externally if the click noise (6) influences system application.
- (10) DZF= "L" for 10~11/fs after PDN= "↑".

Figure 10. Power-down/up sequence example

■ Reset Function

When RSTN = "0", ADC and DACs are powered-down but the internal register are not initialized. The analog outputs go to VCOM voltage, DZF1-2 pins go to "H" and SDTO pin goes to "L". Because some click noise occurs, the analog output should muted externally if the click noise influences system application. Figure 11 shows the power-up sequence.



Notes:

- (1) The analog part of ADC is initialized after exiting the reset state.
- (2) Digital output corresponding to analog input and analog output corresponding to digital input have the group delay (GD).
- (3) ADC output is "0" data at the power-down state.
- (4) Click noise occurs when the internal RSTN bit becomes "1". Please mute the digital output externally if the click noise influences system application.
- (5) The analog outputs go to VCOM voltage.
- (6) Click noise occurs at 4~5/fs after RSTN bit becomes "0", and occurs at 1~2/fs after RSTN bit becomes "1". This noise is output even if "0" data is input.
- (7) The external clocks (MCLK, BICK and LRCK) can be stopped in the reset mode. When exiting the reset mode, "1" should be written to RSTN bit after the external clocks (MCLK, BICK and LRCK) are fed.
- (8) DZF pins go to "H" when the RSTN bit becomes "0", and go to "L" at 6~7/fs after RSTN bit becomes "1".
- (9) There is a delay, 4~5/fs from RSTN bit "0" to the internal RSTN bit "0".

Figure 11. Reset sequence example

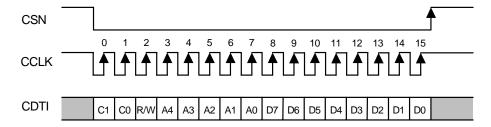
■ Serial Control Interface

The AK4529 can control its functions via registers. Internal registers may be written by 2 types of control mode. The chip address is determined by the state of the CAD0 and CAD1 inputs. PDN = "L" initializes the registers to their default values. Writing "0" to the RSTN bit can initialize the internal timing circuit. But in this case, the register data is not be initialized. When the state of P/S pin is changed, the AK4529 should be reset by PDN pin.

- * Writing to control register is invalid when PDN = "L" or the MCLK is not fed.
- * AK4529 does not support the read command.

(1) 3-wire Serial Control Mode (I2C = "L")

Internal registers may be written to the 3 wire μ P interface pins (CSN, CCLK and CDTI). The data on this interface consists of Chip address (2bits, CAD0/1), Read/Write (1bit, Fixed to "1", Write only), Register address (MSB first, 5bits) and Control data (MSB first, 8bits). Address and data is clocked in on the rising edge of CCLK and data is clocked out on the falling edge. For write operations, data is latched after a low-to-high transition of CSN. The clock speed of CCLK is 5MHz(max). The CSN pin should be held to "H" except for access.



C1-C0: Chip Address (C1=CAD1, C0=CAD0) R/W: Read/Write (Fixed to "1", Write only)

A4-A0: Register Address D7-D0: Control Data

Figure 12. 3-wire Serial Control I/F Timing

(2) I2C-bus Control Mode (I2C= "H")

AK4529 supports the standard-mode I²C-bus (max:100kHz). Then AK4529 cannot be incorporated in a fast-mode I²C-bus system (max:400kHz). The CSN pin should be connected to DVDD at the I²C-bus mode.

Figure 13 shows the data transfer sequence at the I²C-bus mode. All commands are preceded by a START condition. A HIGH to LOW transition on the SDA line while SCL is HIGH indicates a START condition (figure 17). After the START condition, a slave address is sent. This address is 7 bits long followed by an eighth bit which is a data direction bit (R/W) (figure 14). The most significant five bits of the slave address are fixed as "00100". The next two bits are CAD1 and CAD0 (device address bits). These two bits identify the specific device on the bus. The hardwired input pins (CAD1 pin and CAD0 pin) set them. If the slave address match that of the AK4529 and R/W bit is "0", the AK4529 generates the acknowledge and the write operation is executed. If R/W bit is "1", the AK4529 generates the not acknowledge since the AK4529 can be only a slave-receiver. The master must generate the acknowledge-related clock pulse and release the SDA line (HIGH) during the acknowledge clock pulse (figure 18).

The second byte consists of the address for control registers of the AK4529. The format is MSB first, and those most significant 3-bits are fixed to zeros (figure 15). Those data after the second byte contain control data. The format is MSB first, 8bits (figure 16). The AK4529 generates an acknowledge after each byte has been received. A data transfer is always terminated by a STOP condition generated by the master. A LOW to HIGH transition on the SDA line while SCL is HIGH defines a STOP condition (figure 17).

The AK4529 is capable of more than one byte write operation by one sequence. After receipt of the third byte, the AK4529 generates an acknowledge, and awaits the next data again. The master can transmit more than one byte instead of terminating the write cycle after the first data byte is transferred. After the receipt of each data, the internal 5bits address counter is incremented by one, and the next data is taken into next address automatically. If the address exceed 1FH prior to generating the stop condition, the address counter will "roll over" to 00H and the previous data will be overwritten.

The data on the SDA line must be stable during the HIGH period of the clock. The HIGH or LOW state of the data line can only change when the clock signal on the SCL line is LOW (figure 19) except for the START and the STOP condition.

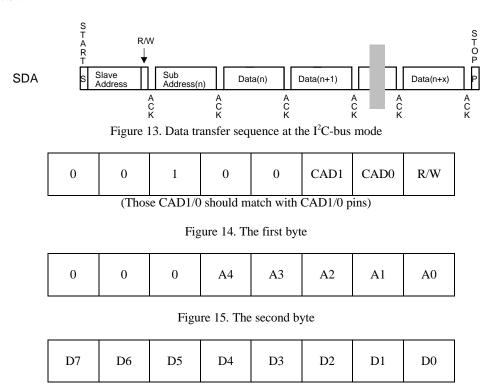


Figure 16. Byte structure after the second byte

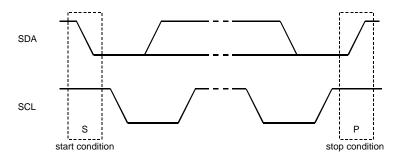


Figure 17. START and STOP conditions

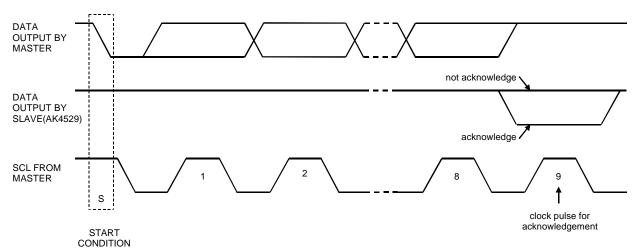


Figure 18. Acknowledge on the I²C-bus

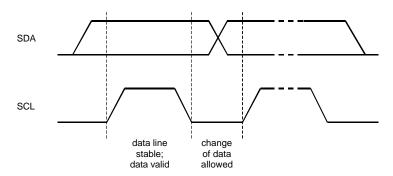


Figure 19. Bit transfer on the I²C-bus

■ Mapping of Program Registers

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
00H	Control 1	0	0	0	TDM	DIF1	DIF0	0	SMUTE
01H	Control 2	0	0	LOOP1	LOOP0	SDOS	DFS	ACKS	0
02H	LOUT1 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
03H	ROUT1 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
04H	LOUT2 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
05H	ROUT2 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
06H	LOUT3 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
07H	ROUT3 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
08H	De-emphasis	DEMD1	DEMD0	DEMA1	DEMA0	DEMB1	DEMB0	DEMC1	DEMC0
09H	ATT speed	0	0	ATS1	ATS0	0	0	0	RSTN
0AH	Zero detect	OVFE	DZFM3	DZFM2	DZFM1	DZFM0	PWVRN	PWADN	PWDAN
0BH	LOUT4 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
0CH	ROUT4 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0

Note: For addresses from 0DH to 1FH, data is not written.

When PDN goes to "L", the registers are initialized to their default values.

When RSTN bit goes to "0", the internal timing is reset and DZF1-2 pins go to "H", but registers are not initialized to their default values.

SMUTE, DFS, SDOS and TDM are ORed with pins.

■ Register Definitions

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
00H	Control 1	0	0	0	TDM	DIF1	DIF0	0	SMUTE
	Default		0	0	0	1	0	0	0

SMUTE: Soft Mute Enable

0: Normal operation

1: All DAC outputs soft-muted

Register bit of $\hat{S}MUTE$ is ORed with the SMUTE pin if P/S = "L".

DIF1-0: Audio Data Interface Modes (see table 7, 8.)

Initial: "10", mode 2

TDM: TDM Format Select

0: Normal format

1: TDM format

Register bit of TDM is ORed with the TDM pin if P/S = L.

TDM pin should be "H" if TDM mode is used.

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
01H	Control 2	0	0	LOOP1	LOOP0	SDOS	DFS	ACKS	0
	Default	0	0	0	0	0	0	0	0

ACKS: Master Clock Frequency Auto Setting Mode Enable

0: Disable, Manual Setting Mode

1: Enable, Auto Setting Mode

Master clock frequency is detected automatically at ACKS bit "1". In this case, the setting of DFS are ignored. When this bit is "0", DFS sets the sampling speed mode.

DFS: Sampling speed mode (see table 1.)

0: Normal speed

1: Double speed

Register bit of DFS is ORed with DFS pin if P/S = L.

The setting of DFS is ignored at ACKS bit "1".

SDOS: SDTO source select

0: ADC

1: DAUX

Register bit of SDOS is ORed with SDOS pin if P/S = L.

SDOS should be set to "0" at TDM bit "1".

LOOP1-0: Loopback mode enable

00: Normal (No loop back)

01: LIN \rightarrow LOUT1, LOUT2, LOUT3, LOUT4

RIN → ROUT1, ROUT2, ROUT3, ROUT4

The digital ADC output (DAUX input if SDOS = "1") is connected to the digital DAC input. In this mode, the input DAC data to SDTI1-3 is ignored. The audio format of SDTO at loopback mode becomes mode 2 at mode 0, and mode 3 at mode 1, respectively.

10: SDTI1(L) \rightarrow SDTI2(L), SDTI3(L), SDTI4(L)

 $SDTI1(R) \rightarrow SDTI2(R)$, SDTI3(R), SDTI4(R)

In this mode the input DAC data to SDTI2-4 is ignored.

11: N/A

LOOP1-0 should be set to "00" at TDM bit "1".

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
02H	LOUT1 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
03H	ROUT1 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
04H	LOUT2 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
05H	ROUT2 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
06H	LOUT3 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
07H	ROUT3 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
0BH	LOUT4 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
0CH	ROUT4 Volume Control	ATT7	ATT6	ATT5	ATT4	ATT3	ATT2	ATT1	ATT0
	Default	0	0	0	0	0	0	0	0

ATT7-0: Attenuation Level (see table 10.)

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
08H	De-emphasis	DEMD1	DEMD0	DEMA1	DEMA0	DEMB1	DEMB0	DEMC1	DEMC0
	Default	0	1	0	1	0	1	0	1

DEMA1-0: De-emphasis response control for DAC1 data on SDTI1 (see table 6.) Initial: "01", OFF

DEMB1-0: De-emphasis response control for DAC2 data on SDTI2 (see table 6.) Initial: "01", OFF

DEMC1-0: De-emphasis response control for DAC3 data on SDTI3 (see table 6.) Initial: "01", OFF

DEMD1-0: De-emphasis response control for DAC4 data on SDTI4 (see table 6.) Initial: "01", OFF

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
09H	ATT speed	0	0	ATS1	ATS0	0	0	0	RSTN
	Default	0	0	0	0	0	0	0	1

RSTN: Internal timing reset

0: Reset. DZF1-2 pins go to "H", but registers are not initialized.

1: Normal operation

ATS1-0: Digital attenuator transition time setting (see table 11.)

Initial: "00", mode 0

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
0AH	Zero detect	OVFE	DZFM3	DZFM2	DZFM1	DZFM0	PWVRN	PWADN	PWDAN
	Default	0	1	1	1	1	1	1	1

PWDAN: Power-down control of DAC1-4

0: Power-down

1: Normal operation

PWADN: Power-down control of ADC

0: Power-down

1: Normal operation

PWVRN: Power-down control of reference voltage

0: Power-down

1: Normal operation

DZFM3-0: Zero detect mode select (see table 9.)

Initial: "0111", disable

OVFE: Overflow detection enable

0: Disable, pin#33 becomes DZF2 pin.

1: Enable, pin#33 becomes OVF pin.

SYSTEM DESIGN

Figure 20 shows the system connection diagram. An evaluation board is available which demonstrates application circuits, the optimum layout, power supply arrangements and measurement results.

Condition: TVDD=5V, 3-wire serial control mode, CAD1-0 = "00"

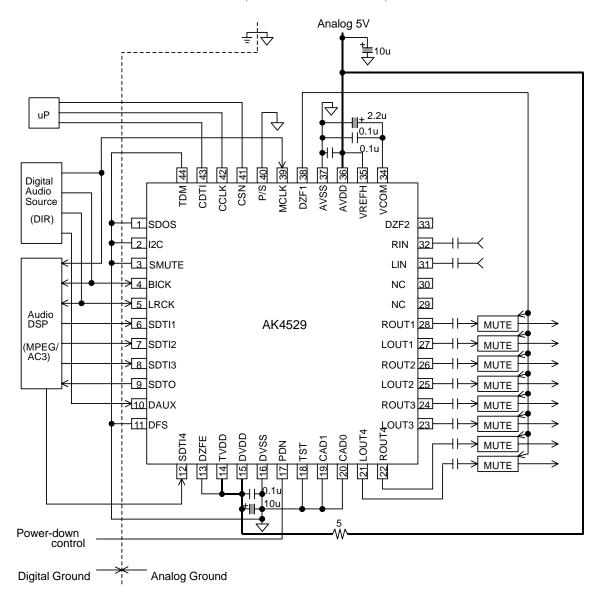


Figure 20. Typical Connection Diagram

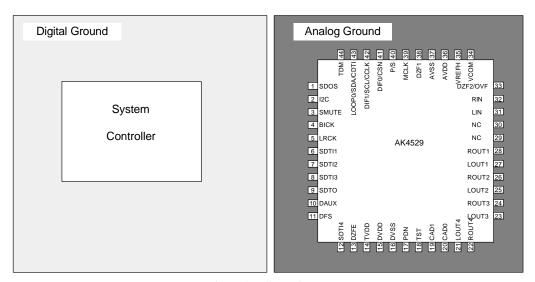


Figure 21. Ground Layout

Note: AVSS and DVSS must be connected to the same analog ground plane.

1. Grounding and Power Supply Decoupling

The AK4529 requires careful attention to power supply and grounding arrangements. AVDD and DVDD are usually supplied from analog supply in system. Alternatively if AVDD and DVDD are supplied separately, the power up sequence is not critical. AVSS and DVSS of the AK4529 must be connected to analog ground plane. System analog ground and digital ground should be connected together near to where the supplies are brought onto the printed circuit board. Decoupling capacitors should be as near to the AK4529 as possible, with the small value ceramic capacitor being the nearest.

2. Voltage Reference Inputs

The voltage of VREFH sets the analog input/output range. VREFH pin is normally connected to AVDD with a $0.1\mu F$ ceramic capacitor. VCOM is a signal ground of this chip. An electrolytic capacitor $2.2\mu F$ parallel with a $0.1\mu F$ ceramic capacitor attached to VCOM pin eliminates the effects of high frequency noise. No load current may be drawn from VCOM pin. All signals, especially clocks, should be kept away from the VREFH and VCOM pins in order to avoid unwanted coupling into the AK4529.

3. Analog Inputs

ADC inputs are single-ended and internally biased to VCOM. The input signal range scales with the supply voltage and nominally $0.62 \times VREFH Vpp (typ)@fs=44.1kHz$. The ADC output data format 2's compliment. The DC offset is removed by the internal HPF.

The AK4529 samples the analog inputs at 64fs. The digital filter rejects noise above the stop band except for multiples of 64fs. The AK4529 includes an anti-aliasing filter (RC filter) to attenuate a noise around 64fs.

4. Analog Outputs

The analog outputs are also single-ended and centered around the VCOM voltage. The input signal range scales with the supply voltage and nominally 0.6 x VREFH Vpp. The DAC input data format is 2's complement. The output voltage is a positive full scale for 7FFFFFH(@24bit) and a negative full scale for 800000H(@24bit). The ideal output is VCOM voltage for 000000H(@24bit). The internal analog filters remove most of the noise generated by the delta-sigma modulator of DAC beyond the audio passband.

DC offsets on analog outputs are eliminated by AC coupling since DAC outputs have DC offsets of a few mV.

■ Peripheral I/F Example

The AK4529 can accept the signal of device with a nominal 3.3V supply because of TTL input. The power supply for output buffer (TVDD) of the AK4529 should be 3.3V when the peripheral devices operate at a nominal 3.3V supply. Figure 22 shows an example with the mixed system of 3.3V and 5V.

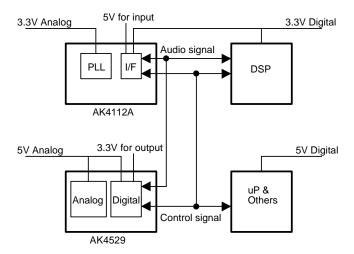


Figure 22. Power supply connection example

■ Applications

1) Zoran AC3 decoder, ZR38650

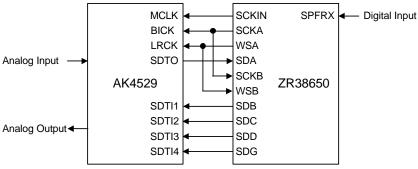


Figure 23. Application circuit example (ZR38650)

2) Yamaha AC3 decoder, YSS912

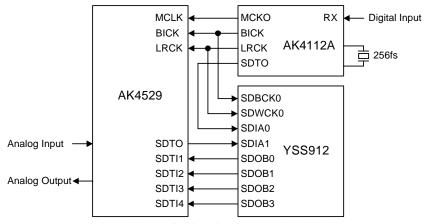


Figure 24. Application circuit example (YSS912)

3) Motorola AC3 decoder, DSP56362

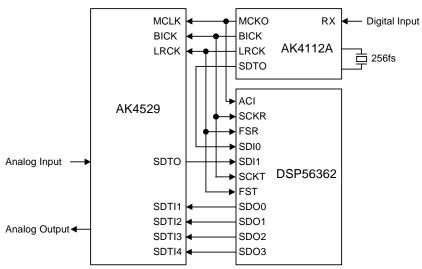
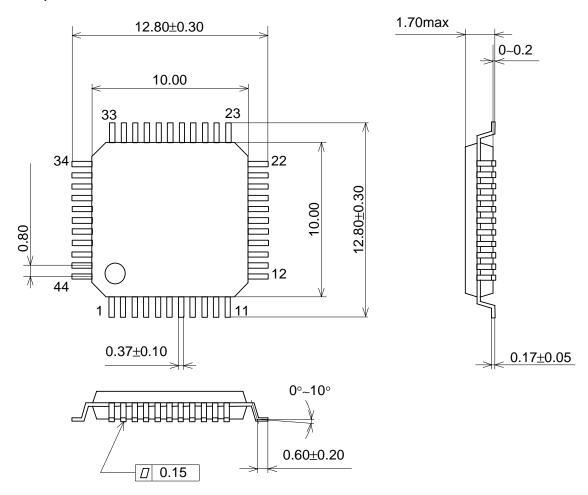


Figure 25. Application circuit example (DSP56362)

PACKAGE

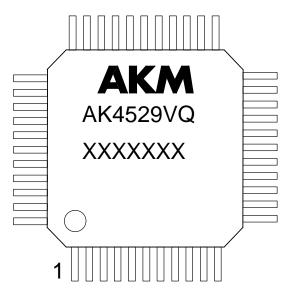
44pin LQFP (Unit: mm)



■ Package & Lead frame material

Package molding compound: Epoxy
Lead frame material: Cu
Lead frame surface treatment: Solder plate

MARKING



1) Pin #1 indication

2) Date Code: XXXXXXX(7 digits)3) Marking Code: AK4529VQ

4) Asahi Kasei Logo

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